

12-Stage Binary Ripple Counter

MC74AC4040

The MC74AC4040 consists of 12 master-slave flip-flops. The output of each flip-flop feeds the next and the frequency at each output is half that of the preceding one. The state of the counter advances on the negative-going edge of the Clock input. Reset is asynchronous and active-high.

State changes of the Q outputs do not occur simultaneously because of internal ripple delays. Therefore, decoded output signals are subject to decoding spikes and may have to be gated with the Clock of the MC74AC4040 for some designs.

Features

- 140 MHz Typ. Clock
- Outputs Source/Sink 24 mA
- Operating Voltage Range: 2.0 to 6.0 V
- High Noise Immunity
- These are Pb-Free Devices

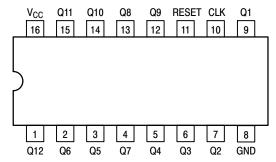


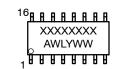
Figure 1. Pinout: 16-Lead Packages Conductors (Top View)

FUNCTION TABLE

Clock	Reset	Output State
	L	No Change
	L	Advance to next state
X	Н	All Outputs are low



MARKING DIAGRAM



XXXX = Specific Device Code A = Assembly Location

WL = Wafer Lot
 Y = Year
 WW = Work Week
 G = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

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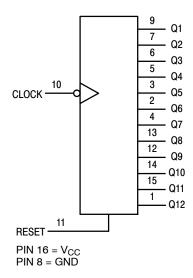


Figure 2. Logic Diagram

MAXIMUM RATINGS

Symbol	Parame	ter	Value	Unit
V _{CC}	DC Supply Voltage		-0.5 to +6.5	V
VI	DC Input Voltage		$-0.5 \le V_{CC} + 0.5$	V
Vo	DC Output Voltage (Note 1)		$-0.5 \le V_{CC} + 0.5$	V
I _{IK}	DC Input Diode Current		±20	mA
l _{ok}	DC Output Diode Current		±50	mA
Io	DC Output Sink/Source Current		±50	mA
I _{CC}	DC Supply Current per Output Pin		±50	mA
I _{GND}	DC Ground Current per Output Pin		±50	mA
T _{STG}	Storage Temperature Range		-65 to +150	°C
TL	Lead temperature, 1 mm from Case for	r 10 Seconds	260	°C
TJ	Junction temperature under Bias		+150	°C
θ_{JA}	Thermal Resistance (Note 2)		126	°C/W
P _D	Power Dissipation in Still Air at 25°C		995	mW
MSL	Moisture Sensitivity		Level 1	
F _R	Flammability Rating	Oxygen Index: 30% – 35%	UL 94 V-0 @ 0.125 in	
V _{ESD}	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model	> 2000 > 1000	V
I _{Latch-Up}	Latch-Up Performance (Note 4)		±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality

- stresses exceeding those listed in the Maximum Hatings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

 1. Io absolute maximum rating must be observed.

 2. The package thermal impedance is calculated in accordance with JESD51–7.

 3. HBM tested to EIA / JESD22–A114–A. CDM tested to JESD22–C101–A. JEDEC recommends that ESD qualification to EIA/JESD22–A115A (Machine Model) be discontinued.
- 4. Tested to EIA/JÉSD78 Class II.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V _{CC}	DC Supply Voltage (Referenced to GND)	2.0	6.0	V
V _{IN} /V _{OUT}	Input Voltage, Output Voltage (Referenced to GND)	0	V _{CC}	-
T _A	Operating Temperature, All Package Types	-40	+85	°C
t _r /t _f	Input Rise/Fall Time $ \begin{array}{c} \text{V}_{CC} = 3.0 \text{ V} \\ \text{(Figure 1)} \end{array} $ $ \begin{array}{c} \text{V}_{CC} = 4.5 \text{ V} \\ \text{V}_{CC} = 5.5 \text{ V} \end{array} $	0 0 0	150 40 25	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC CHARACTERISTICS (unless otherwise specified)

Symbol	Parameter	Conditions	Value	Unit
I _{CC}	Maximum Quiescent Supply Voltage	$V_{in} = V_{CC}$ or GND $V_{CC} = 5.5 \text{ V}$, $T_A = \text{Worst Case}$	80	μΑ
I _{CC}	Maximum Quiescent Supply Current	$V_{in} = V_{CC}$ or GND $V_{CC} = 5.5 \text{ V}, T_A = 25^{\circ}\text{C}$	8.0	μΑ

DC CHARACTERISTICS

				74AC		74AC	
			V _{cc}	T _A = +	-25°C	T _A = -40°C to +85°C	
Symbol	Parameter	Conditions	(V)	Тур	G	uaranteed Limits	Unit
V _{IH}	Minimum High Level Input Voltage	V _{OUT} = 0.1 V or V _{CC} – 0.1 V	3.0 4.5 5.5	- - -	2.1 3.15 3.85	2.1 3.15 3.85	V
V _{IL}	Maximum Low Level Input Voltage	V _{OUT} = 0.1 V or V _{CC} – 0.1 V	3.0 4.5 5.5	- - -	0.9 1.35 1.65	0.9 1.35 1.65	V
V _{OH}	Minimum High Level Output Voltage	I _{OUT} = -50 μA	3.0 4.5 5.5	2.99 4.49 5.49	2.9 4.4 5.4	2.9 4.4 5.4	V
		$*V_{IN} = V_{IL} \text{ or } V_{IH}$ -12 mA I_{OH} -24 mA	3.0 4.5 5.5		2.56 3.86 4.86	2.46 3.76 4.76	٧
V _{OL}	Maximum Low Level Output Voltage	Ι _{ΟUT} = 50 μΑ	3.0 4.5 5.5	0.002 0.001 0.001	0.1 0.1 0.1	0.1 0.1 0.1	٧
		$^{\star V_{\text{IN}} = V_{\text{IL}} \text{ or } V_{\text{IH}}}_{\text{12 mA}}$ $^{\text{I}_{\text{OL}}}_{\text{OL}} = ^{24} \text{ mA}$ $^{\text{24 mA}}_{\text{24 mA}}$	3.0 4.5 5.5	- - -	0.36 0.36 0.36	0.44 0.44 0.44	V
I _{IN}	Maximum Input Leakage Current	V _I = V _{CC} , GND	5.5	-	±0.1	±1.0	μΑ
I _{OLD}	Minimum Dynamic Output Current†	V _{OLD} = 1.65 V Max	5.5	-	-	75	mA
I _{OHD}	1	V _{OHD} = 3.85 V Min	5.5	-	_	-75	mA

^{*}All outputs loaded; thresholds on input associated with output under test. \dagger Maximum test duration 2.0 ms, one output loaded at a time.

AC CHARACTERISTICS (For Figures and Waveforms - See Section 3 of the ON Semiconductor FACT Data Book, DL138/D)

				74AC		74	AC		
			V _{CC} *		_A = +25° _L = 50 p		T _A = -40°C C _L = 9		
Symbol	Parameter	Conditions	(V)	Min	Тур	Max	Min	Max	Unit
f _{max}	Maximum Clock Frequency		3.3 5.0	110 130	120 140	-	100 120	-	MHz
n _{CP} to Q1	Propagation Delay n _{CP} to Q1		3.3 5.0	2.0 2.0	- -	11 8.0	2.0 2.0	14 10	ns
Q _n to Q _n +1	Propagation Delay Q _n to Q _n +1		3.3 5.0	0 0	-	5.5 3.5	0 0	6.5 4.5	ns
MR to Q t _{HL}	Propagation Delay MR to Q		3.3 5.0	3.0 3.0	- -	12 10	3.0 3.0	15 12	ns
t _{rec} n _{CP} to MR	Recovery Time		3.3 5.0	0 0	-2.5 -1.5	- -	0 0	-	ns
t _w n _{CP}	Minimum Pulse Width Clock Pin		3.3 5.0	4.0 3.0	3.5 2.5	1 1	4.5 3.5	- -	ns
t _w MR	Minimum Pulse Width Master Reset		3.3 3.0	4.0 3.0	3.5 2.5	1 1	4.5 3.5	- -	ns

CAPACITANCE

Symbol	Parameter	Conditions	Value Typ	Unit
C _{IN}	Input Capacitance	V _{CC} = 5.0 V	4.5	pF
C _{PD}	Power Dissipation Capacitance	V _{CC} = 5.0 V	50	pF

ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
MC74AC4040DR2G	AC4040G	SOIC-16 (Pb-Free)	2,500 Tape & Reel

^{*}Voltage Range 3.3 V is 3.3 V ± 0.3 V. *Voltage Range 5.0 V is 5.0 V ± 0.5 V.



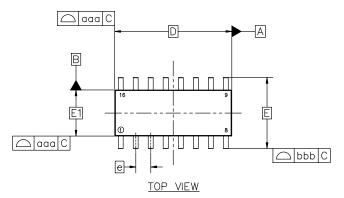


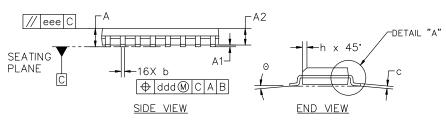
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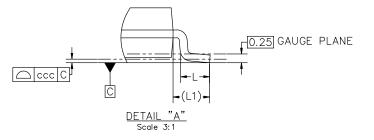
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NOTES:

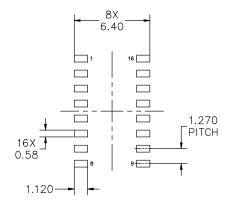
- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. DIMENSION IN MILLIMETERS. ANGLE IN DEGREES.
- 3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD PROTRUSION.
- 4. MAXIMUM MOLD PROTRUSION 0.15mm PER SIDE.
- 5. DIMENSION 6 DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127mm TOTAL IN EXCESS OF THE 6 DIMENSION AT MAXIMUM MATERIAL CONDITION.







MILLIMETERS							
DIM	MIN	NOM	MAX				
А	1.35	1.55	1.75				
A1	0.10	0.18	0.25				
A2	1.25	1.37	1.50				
b	0.35	0.42	0.49				
С	0.19	0.22	0.25				
D		9.90 BSC					
E		6.00 BSC					
E1		3.90 BSC					
е		1.27 BSC					
h	0.25		0.50				
L	0.40	0.83	1.25				
L1		1.05 REF					
Θ	0.		7*				
TOLERAN	CE OF FC	RM AND	POSITION				
aaa	0.10						
bbb	0.20						
ccc	0.10						
ddd		0.25					
eee		0.10					



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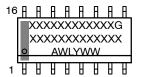
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ISSUE M

DATE 18 OCT 2024

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code A = Assembly Location

WL = Wafer Lot
 Y = Year
 WW = Work Week
 G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1:		STYLE 2:		STYLE 3:	S	STYLE 4:	
PIN 1.	COLLECTOR	PIN 1.	CATHODE	PIN 1.	COLLECTOR, DYE #1	PIN 1.	COLLECTOR, DYE #1
2.	BASE	2.	ANODE	2.	BASE, #1	2.	COLLECTOR, #1
3.	EMITTER	3.	NO CONNECTION	3.	EMITTER, #1	3.	COLLECTOR, #2
4.	NO CONNECTION	4.	CATHODE	4.	COLLECTOR, #1	4.	
5.	EMITTER	5.	CATHODE	5.	COLLECTOR, #2	5.	
6.	BASE	6.	NO CONNECTION	6.	BASE, #2	6.	COLLECTOR, #3
7.	COLLECTOR	7.	ANODE	7.	EMITTER, #2	7.	COLLECTOR, #4
8.	COLLECTOR	8.	CATHODE	8.	COLLECTOR, #2	8.	COLLECTOR, #4
9.	BASE	9.	CATHODE	9.	COLLECTOR, #3	9.	BASE, #4
10.	EMITTER	10.	ANODE	10.	BASE, #3	10.	EMITTER, #4
11.	NO CONNECTION	11.	NO CONNECTION	11.	EMITTER, #3	11.	BASE, #3
12.	EMITTER	12.	CATHODE	12.	COLLECTOR, #3	12.	EMITTER, #3
13.	BASE	13.	CATHODE	13.	COLLECTOR, #4	13.	BASE, #2
14.	COLLECTOR	14.		14.	BASE, #4	14.	EMITTER, #2
15.	EMITTER		ANODE	15.		15.	
16.	COLLECTOR	16.	CATHODE	16.	COLLECTOR, #4	16.	EMITTER, #1
STYLE 5:		STYLE 6:		STYLE 7:			
PIN 1.	DRAIN, DYE #1	PIN 1.	CATHODE	PIN 1.	SOURCE N-CH		
2.	DRAIN, #1	2.	CATHODE	2.	COMMON DRAIN (OUTPUT)		
3.	DRAIN, #2	3.	CATHODE	3.)	
4.	DRAIN, #2	4.		4.			
5.	DRAIN, #3	5.		5.			
6.	DRAIN, #3	6.		6.	COMMON DRAIN (OUTPUT)		
7.	DRAIN, #4		CATHODE	7.	COMMON DRAIN (OUTPUT))	
8.	DRAIN, #4	8.		8.	SOURCE P-CH		
9.	GATE, #4	9.		9.	SOURCE P-CH		
10.	SOURCE, #4	10.		10.			
11.	GATE, #3		ANODE	11.			
12.	SOURCE, #3	12	ANODE	12.)	
13.	GATE, #2	13.	ANODE	13.			
14.	GATE, #2 SOURCE, #2	13. 14.	ANODE	14.	COMMON DRAIN (OUTPUT)		
14. 15.	GATE, #2 SOURCE, #2 GATE, #1	13. 14. 15.	ANODE ANODE	14. 15.	COMMON DRAIN (OUTPUT) COMMON DRAIN (OUTPUT)		
14.	GATE, #2 SOURCE, #2	13. 14.	ANODE	14.	COMMON DRAIN (OUTPUT)		

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